COMPLIANT

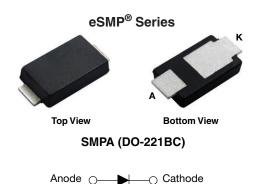
HALOGEN

FREE



### Vishay General Semiconductor

# Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier



#### **LINKS TO ADDITIONAL RESOURCES**



PRIMARY CHARACTERISTICS				
I <sub>F(AV)</sub>	8.0 A			
V <sub>RRM</sub>	50 V			
I <sub>FSM</sub>	120 A			
$V_F$ at $I_F = 8.0 \text{ A} (T_A = 125 ^{\circ}\text{C})$	0.40 V			
T <sub>J</sub> max.	150 °C			
Package	SMPA (DO-221BC)			
Circuit configuration	Single			

#### **FEATURES**

- Very low profile typical height of 0.95 mm
- · Ideal for automated placement
- Trench MOS Schottky technology
- · Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **TYPICAL APPLICATIONS**

For use in low voltage, high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

#### **MECHANICAL DATA**

Case: SMPA (DO-221BC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD22-B102

M3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	V8PAL50	UNIT	
Device marking code		8L5		
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	50	V	
Maximum DC forward current	I <sub>F</sub> <sup>(1)</sup>	8.0	А	
	I <sub>F</sub> <sup>(2)</sup>	4.0		
Maximum DC reverse voltage	V <sub>DC</sub>	35	V	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	120	А	
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	-40 to +150	°C	

#### **Notes**

- $^{(1)}$  Units mounted on 3 cm x 3 cm Aluminum, 2 oz. PCB
- (2) Free air, mounted on recommended copper pad area



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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	$I_F = 4.0 A$	T <sub>A</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.43	-	V
	$I_F = 8.0 A$			0.49	0.57	
	$I_F = 4.0 A$	T <sub>A</sub> = 125 °C		0.32	-	
	I <sub>F</sub> = 8.0 A			0.40	0.48	
Reverse current	V <sub>R</sub> = 35 V	, T <sub>A</sub> = 25 °C	I <sub>R</sub> <sup>(2)</sup>	10	-	μA
	v <sub>R</sub> = 35 v	T <sub>A</sub> = 125 °C		8.4	-	mA
	V 50.V	T <sub>A</sub> = 25 °C		-	400	μA
	$V_R = 50 \text{ V}$	T <sub>A</sub> = 125 °C		15	40	mA
Typical junction capacitance	4.0 V, 1 MHz		CJ	1400	-	pF

#### **Notes**

 $^{(1)}\,$  Pulse test: 300  $\mu s$  pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 5 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise specified)				
PARAMETER	SYMBOL V8PAL50		UNIT	
Typical thermal resistance	R <sub>0JA</sub> (1)	100	°C/W	
	R <sub>0JM</sub> (2)	5	5/44	

#### Notes

- $^{(1)}$  Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance  $R_{\theta JA}$  junction to ambient
- $^{(2)}$  Units mounted on 3 cm x 3 cm Aluminum, 2 oz. pad area; thermal resistance  $R_{\theta JM}$  junction to mount

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
V8PAL50-M3/I	0.032	l	14 000	13" diameter plastic tape and reel	

### RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise specified)

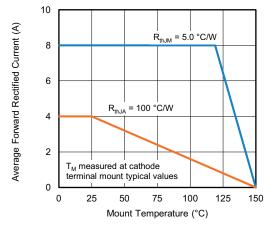


Fig. 1 - Maximum Forward Currernt Derating Curve

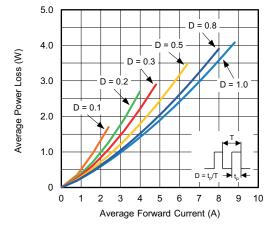


Fig. 2 - Forward Power Loss Characteristics

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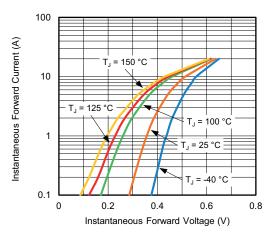


Fig. 3 - Typical Instantaneous Forward Characteristics

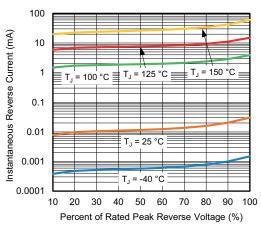


Fig. 4 - Typcial Reverse Leakage Characteristics

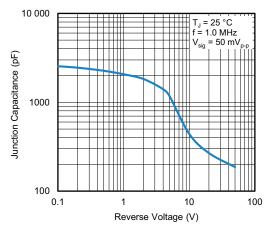


Fig. 5 - Typical Junction Capacitance

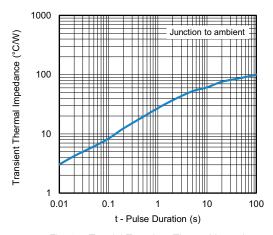


Fig. 6 - Typcial Transient Thermal Impedance

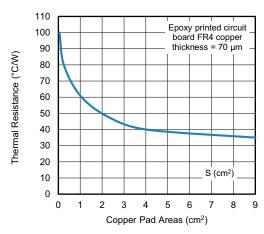


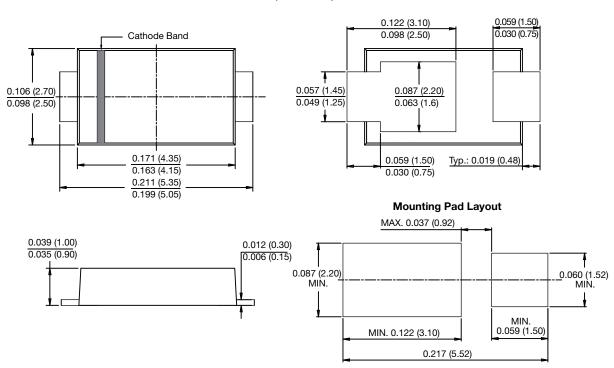
Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Areas



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### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

#### **SMPA (DO-221BC)**





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